BFP843

Robust low noise broadband pre-matched RF bipolar transistor

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Product description

The BFP843 is a robust low noise broadband pre-matched RF heterojunction bipolar transistor (HBT).

Feature list

- Unique combination of high end RF performance and robustness: 20 dBm maximum RF input power, 1.5 kV HBM ESD hardness
- High transition frequency enables best in class noise performance at high frequencies: NF_{min} = 1.2 dB at 5.5 GHz, 1.8 V, 8 mA
- High gain G_{ma} = 17 dB at 5.5 GHz, 1.8 V, 15 mA
- OIP_3 = 19.5 dBm at 5.5 GHz, 1.8 V, 15 mA
- Suitable for low voltage applications e.g. V_{CC} = 1.2 V and 1.8 V (2.85 V, 3.3 V, 3.6 V require a corresponding collector resistor)

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Potential applications

- WLAN, WiMAX and UWB
- Satellite communication systems: satellite radio (SDARs, DAB) and navigation systems (e.g. GPS, GLONASS, BeiDou, Galileo)

Device information

Table 1 Part information

Product name / Ordering code	Package	Pin configuration				Marking	Pieces / Reel
BFP843 / BFP843H6327XTSA1	SOT343	1 = B	2 = E	3 = C	4 = E	T2s	3000

Attention: ***ESD (Electrostatic discharge) sensitive device, observe handling precautions***

Table of contents

1 Absolute maximum ratings

Table 2 Absolute maximum ratings at T_A = 25 °C (unless otherwise specified)

Parameter	Symbol	Values		Unit	Note or test condition
		Min.	Max.		
Collector emitter voltage	V_{CEO}	–	2.25	V	Open base
			2.0		T_A = -55 °C, open base
Collector emitter voltage [1]	V_{CES}		2.25		E-B short circuited
			2.0		T_A = -55 °C, E-B short circuited
Collector base voltage [2]	V_{CBO}		2.9		Open emitter
			2.6		T_A = -55 °C, open emitter
Base current	I_B	-5	5	mA	–
Collector current	I_C	–	55		
RF input power	P_{RFin}	–	20	dBm	
ESD stress pulse	V_{ESD}	-1.5	1.5	kV	HBM, all pins, acc. to JESD22-A114
Total power dissipation [3]	P_{tot}	–	125	mW	$T_S \leq 99$ °C
Junction temperature	T_J	–	150	°C	–
Storage temperature	T_{Stg}	-55			

Attention: ***Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the integrated circuit.***

1 V_{CES} is similar to V_{CEO} due to design.
2 V_{CBO} is similar to V_{CEO} due to design.
3 T_S is the soldering point temperature. T_S is measured on the emitter lead at the soldering point of the PCB.

2 Thermal characteristics

Table 3 Thermal resistance

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Junction - soldering point	R_{thJS}	–	405	–	K/W	–

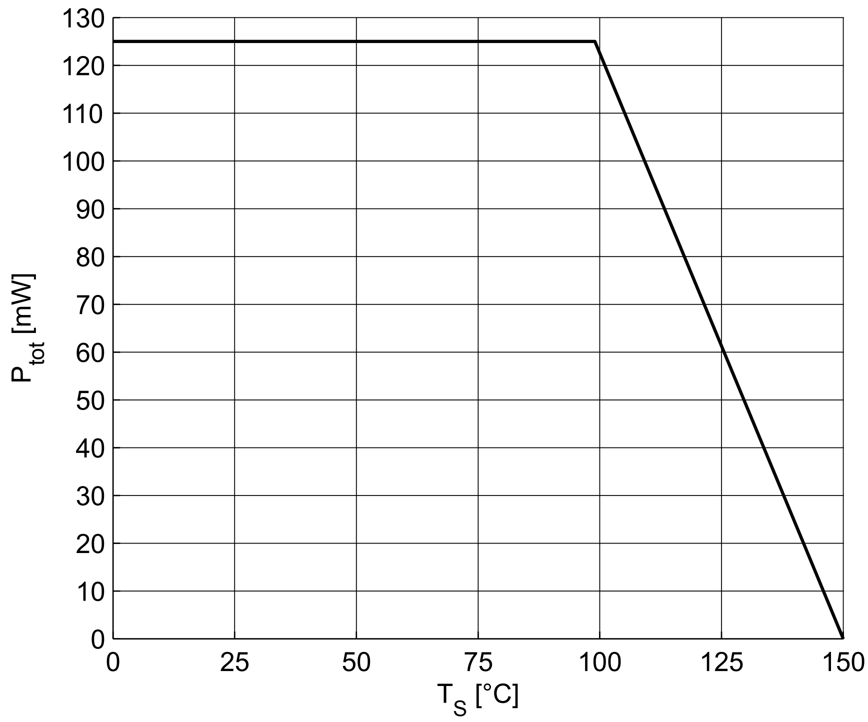

Figure 1 Total power dissipation P_{tot} = f(T_S)

3 Electrical characteristics

3.1 DC characteristics

Table 4 DC characteristics at T_A = 25 °C

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Collector emitter breakdown voltage	$V_{(BR)CEO}$	2.25	2.6	–	V	I_C = 1 mA, I_B = 0, open base
Collector emitter leakage current	I_{CES}	–	–	400 [1]	nA	V_{CE} = 1.5 V, V_{BE} = 0, E-B short circuited
Collector base leakage current	I_{CBO}			400 [1]		V_{CB} = 1.5 V, I_E = 0, open emitter
Emitter base leakage current	I_{EBO}			10 [1]	µA	V_{EB} = 0.5 V, I_C = 0, open collector
DC current gain	h_{FE}	150	260	450	–	V_{CE} = 1.8 V, I_C = 15 mA, pulse measured

3.2 General AC characteristics

Table 5 General AC characteristics at T_A = 25 °C

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Collector base capacitance [2]	C_{CB}	–	5.23 0.06	–	pF	f = 1 MHz, f = 1 GHz, V_{CB} = 1.8 V, V_{BE} = 0, emitter grounded
Collector emitter capacitance	C_{CE}		0.5			f = 1 MHz, V_{CE} = 1.8 V, V_{BE} = 0, base grounded
Emitter base capacitance	C_{EB}		0.73			f = 1 MHz, V_{EB} = 0.4 V, V_{CB} = 0, collector grounded

1 Maximum values not limited by the device but by the short cycle time of the 100% test
2 Including integrated feedback capacitance

3.3 Frequency dependent AC characteristics

Measurement setup is a test fixture with Bias-T's in a 50 Ω system, T_A = 25 °C.

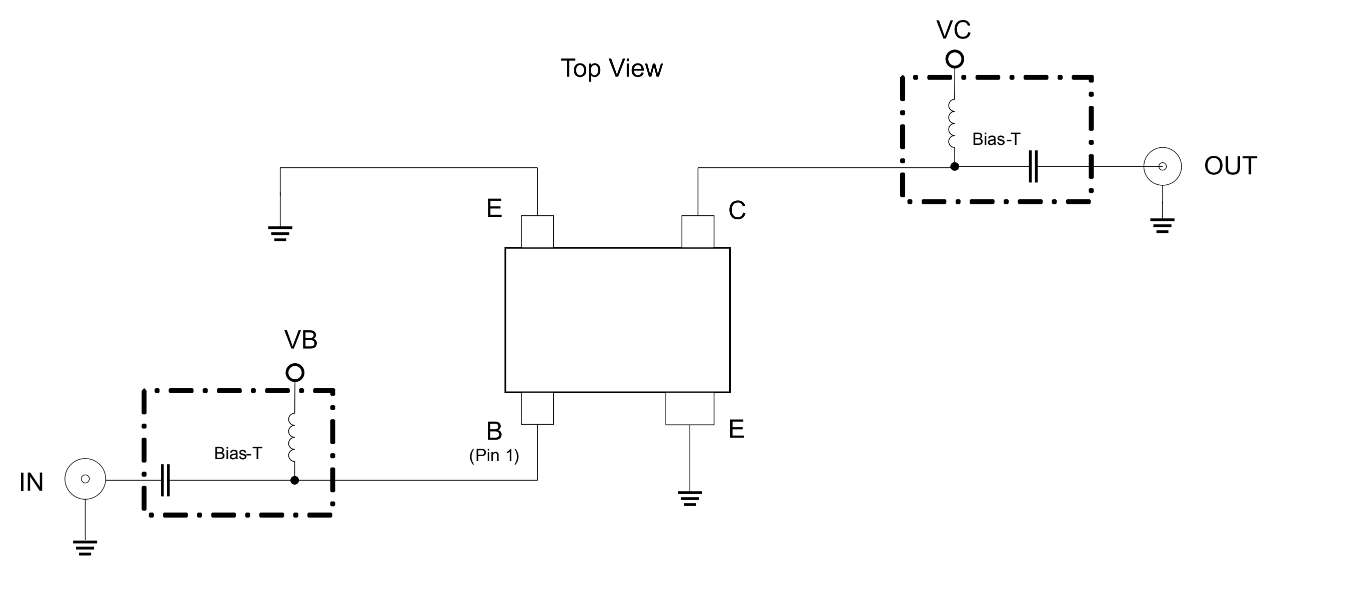

Figure 2 **Testing circuit**

Table 6 **AC characteristics, V_{CE} = 1.8 V, f = 450 MHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain • Maximum power gain • Transducer gain	 G_{ma} $\|S_{21}\|^2$	–	 24.5 24.5	–	dB	I_C = 15 mA
Noise figure • Minimum noise figure • Associated gain	 NF_{min} G_{ass}		 0.9 22			I_C = 8 mA
Linearity • 3rd order intercept point at output • 1 dB gain compression point at output	 OIP_3 OP_{1dB}		 24 7		dBm	I_C = 15 mA, Z_S = Z_L = 50 Ω

Table 7 AC characteristics, V_{CE} = 1.8 V, f = 900 MHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ma}		24			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		24			
Noise figure						
• Minimum noise figure	NF_{min}		0.9			I_C = 8 mA
• Associated gain	G_{ass}		22			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		23.5			I_C = 15 mA, $Z_S = Z_L$ = 50 Ω
• 1 dB gain compression point at output	OP_{1dB}		8			

Table 8 AC characteristics, V_{CE} = 1.8 V, f = 1.5 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ma}		23.5			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		23			
Noise figure						
• Minimum noise figure	NF_{min}		0.95			I_C = 8 mA
• Associated gain	G_{ass}		21			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		22.5			I_C = 15 mA, $Z_S = Z_L$ = 50 Ω
• 1 dB gain compression point at output	OP_{1dB}		6			

Table 9 AC characteristics, V_{CE} = 1.8 V, f = 1.9 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ma}		22.5			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		22			
Noise figure						
• Minimum noise figure	NF_{min}		0.95			I_C = 8 mA
• Associated gain	G_{ass}		20			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		24			I_C = 15 mA, $Z_S = Z_L$ = 50 Ω
• 1 dB gain compression point at output	OP_{1dB}		8.5			

Electrical characteristics

Table 10 AC characteristics, V_{CE} = 1.8 V, f = 2.4 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ma}		21.5			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		21			
Noise figure						
• Minimum noise figure	NF_{min}		1.0			I_C = 8 mA
• Associated gain	G_{ass}		19.5			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		22			I_C = 15 mA, $Z_S = Z_L$ = 50 Ω
• 1 dB gain compression point at output	OP_{1dB}		6.5			

Table 11 AC characteristics, V_{CE} = 1.8 V, f = 3.5 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ma}		19.5			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		19			
Noise figure						
• Minimum noise figure	NF_{min}		1.1			I_C = 8 mA
• Associated gain	G_{ass}		17.5			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		22.5			I_C = 15 mA, $Z_S = Z_L$ = 50 Ω
• 1 dB gain compression point at output	OP_{1dB}		7			

Table 12 AC characteristics, V_{CE} = 1.8 V, f = 5.5 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ma}		17			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		15.5			
Noise figure						
• Minimum noise figure	NF_{min}		1.2			I_C = 8 mA
• Associated gain	G_{ass}		15			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		19.5			I_C = 15 mA, $Z_S = Z_L$ = 50 Ω
• 1 dB gain compression point at output	OP_{1dB}		4			

Table 13 **AC characteristics, V_{CE} = 1.8 V, f = 10 GHz**

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	
• Maximum power gain	G_{ma}		13.5			I_C = 15 mA
• Transducer gain	$\|S_{21}\|^2$		8.5			
Noise figure						
• Minimum noise figure	NF_{min}		1.85			I_C = 8 mA
• Associated gain	G_{ass}		9			
Linearity					dBm	
• 3rd order intercept point at output	OIP_3		16			I_C = 15 mA, $Z_S = Z_L$ = 50 Ω
• 1 dB gain compression point at output	OP_{1dB}		0			

Note: *$G_{ms} = IS_{21} / S_{12}I$ for $k < 1$; $G_{ma} = IS_{21} / S_{12}I(k-(k^2-1)^{1/2})$ for $k > 1$. In order to get the NF_{min} values stated in this chapter, the test fixture losses have been subtracted from all measured results. OIP_3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.2 MHz to 12 GHz.*

3.4 Characteristic DC diagrams

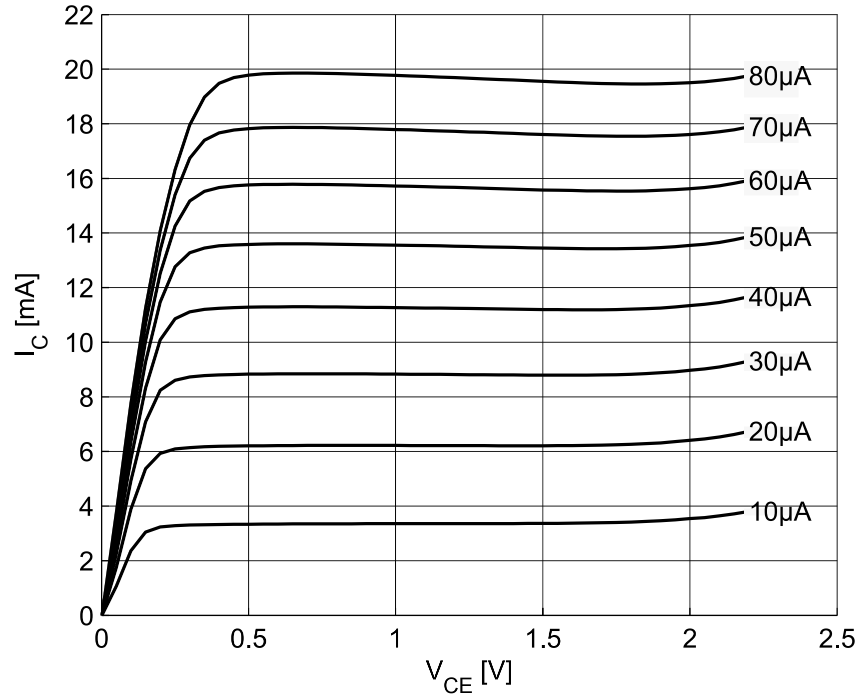

Figure 3 **Collector current vs. collector emitter voltage I_C = f(V_{CE}), I_B = parameter**

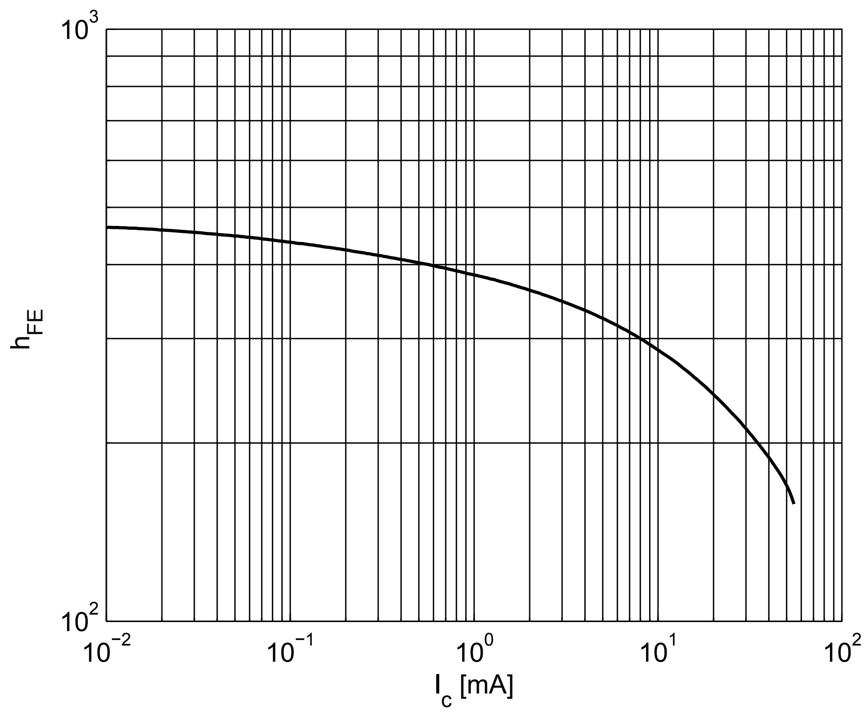

Figure 4 **DC current gain h_{FE} = f(I_C), V_{CE} = 1.8 V**

Electrical characteristics

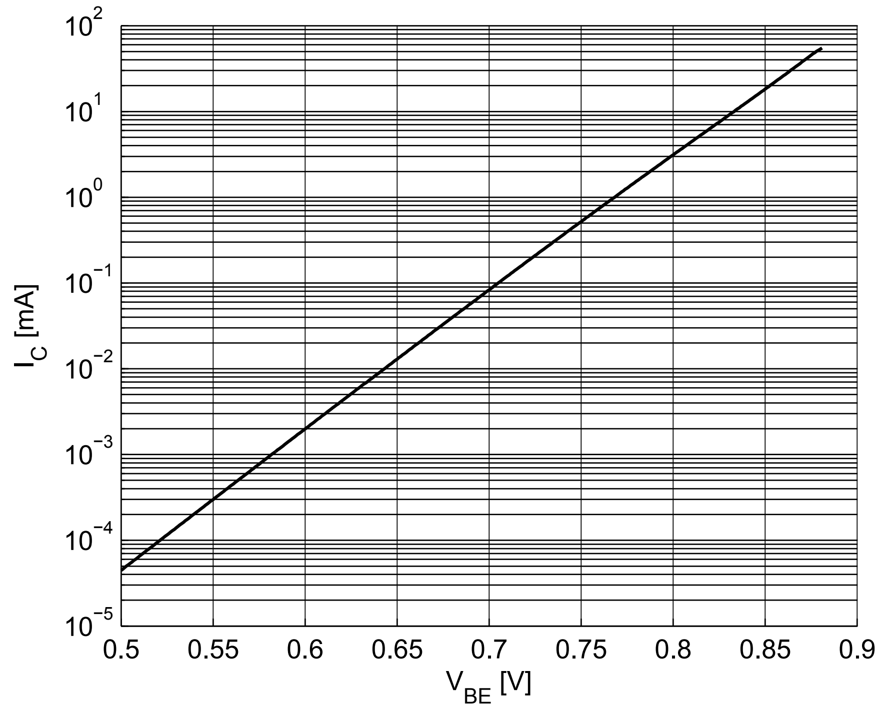

Figure 5 **Collector current vs. base emitter forward voltage $I_C = f(V_{BE})$, $V_{CE} = 1.8$ V**

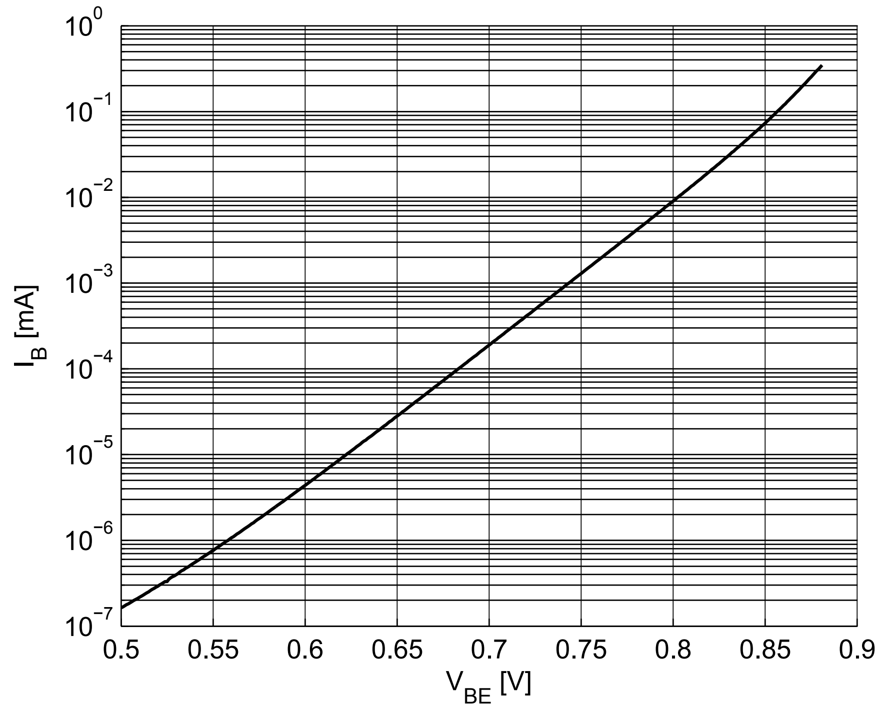

Figure 6 **Base current vs. base emitter forward voltage $I_B = f(V_{BE})$, $V_{CE} = 1.8$ V**

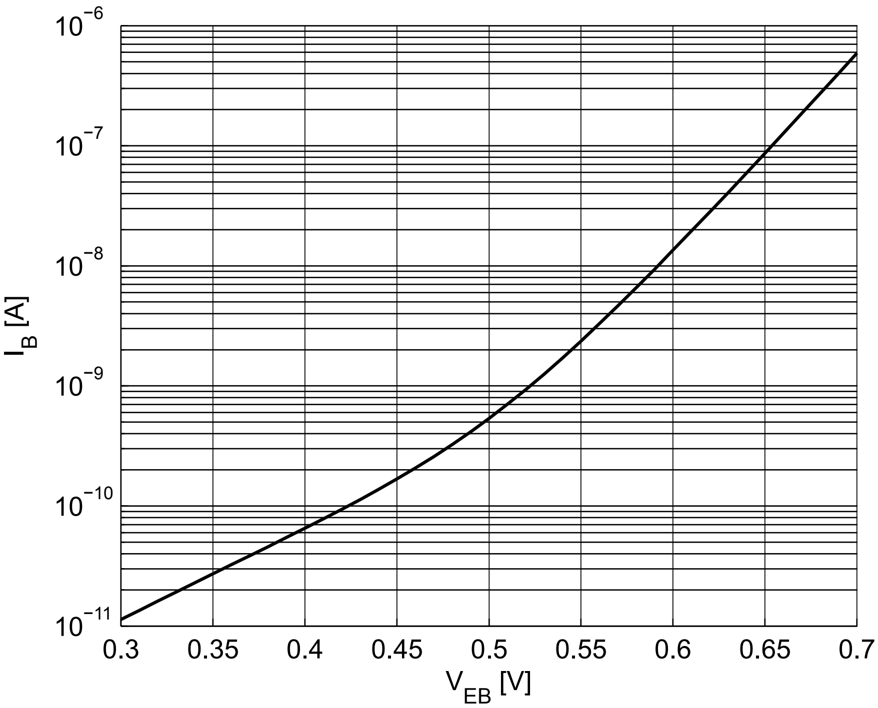

Figure 7 **Base current vs. base emitter reverse voltage I_B = f(V_{EB}), V_{CE} = 1.8 V**

3.5 Characteristic AC diagrams

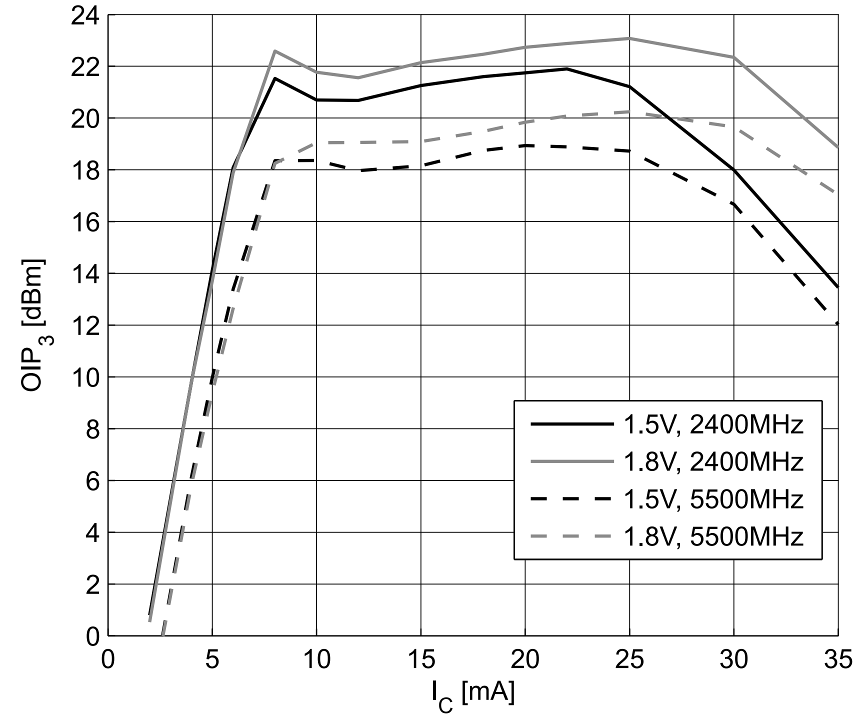

Figure 8 **3rd order intercept point at output OIP_3 = f(I_C), Z_S = Z_L = 50 Ω, V_{CE}, f = parameters**

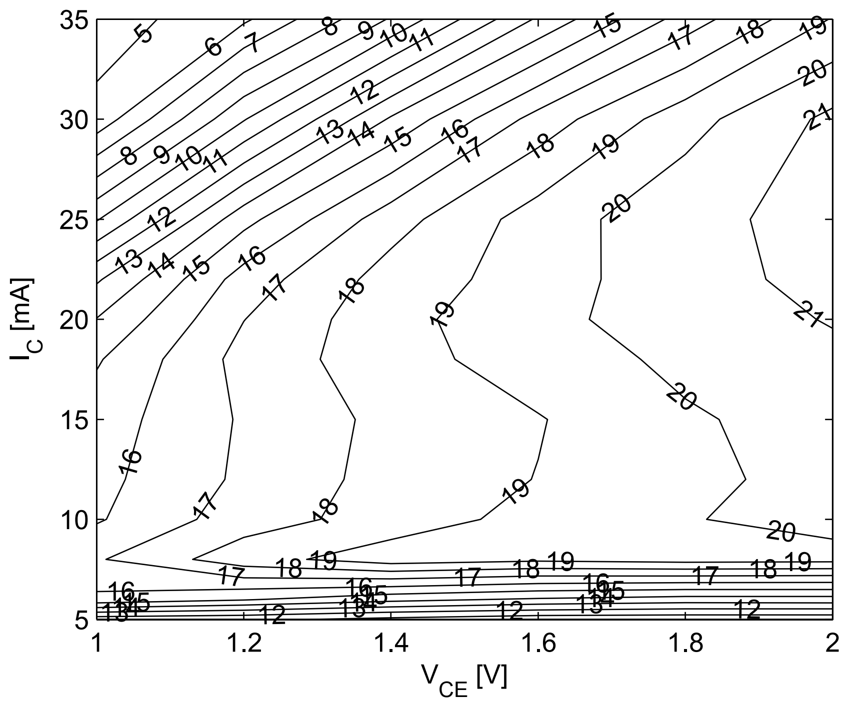

Figure 9 **3rd order intercept point at output OIP_3 [dBm] = f(I_C, V_{CE}), Z_S = Z_L = 50 Ω, f = 5.5 GHz**

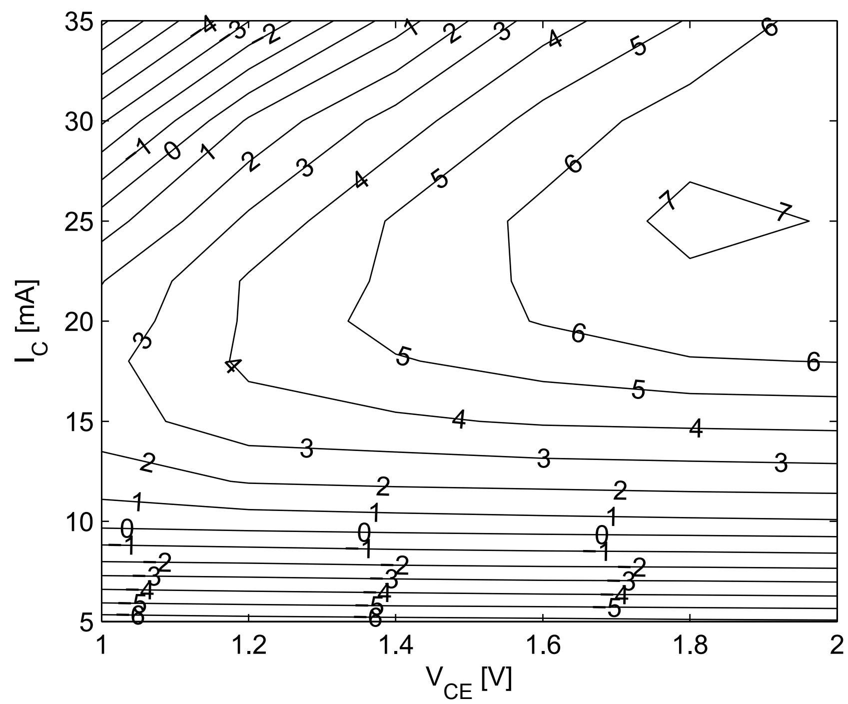

Figure 10 Compression point at output OP_{1dB} [dBm] = f(I_C, V_{CE}), $Z_S = Z_L = 50\ \Omega$, $f = 5.5$ GHz

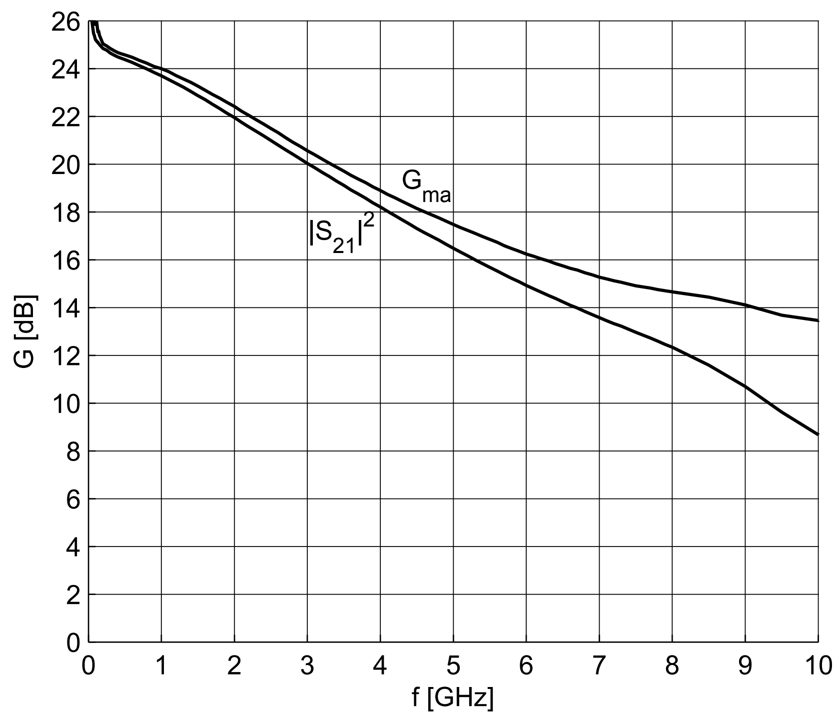

Figure 11 Gain G_{ma}, $|S_{21}|^2$ = f(f), $V_{CE} = 1.8$ V, $I_C = 15$ mA

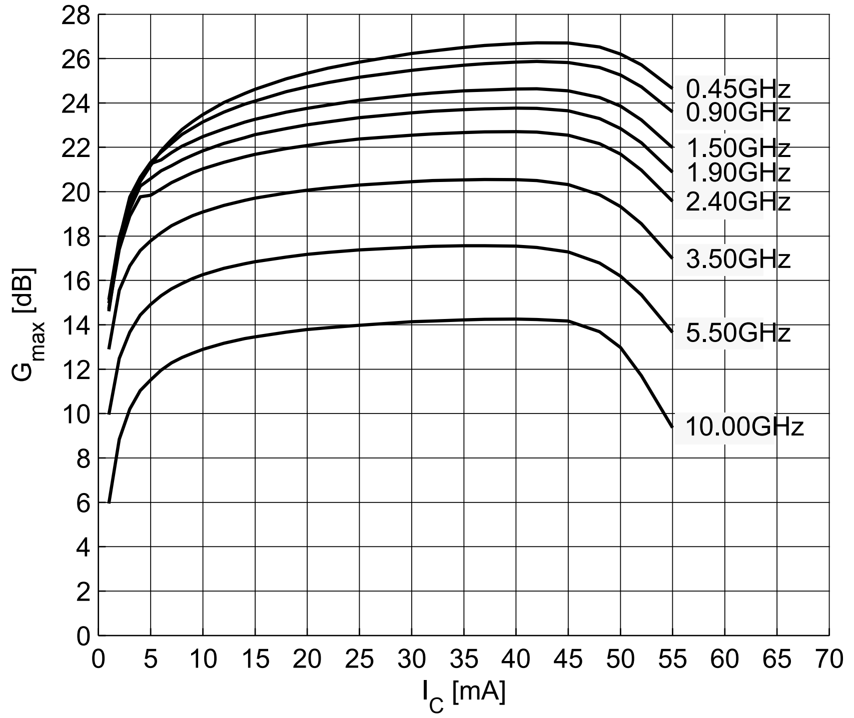

Figure 12 **Maximum power gain G_{max} = f(I_C), V_{CE} = 1.8 V, f = parameter in GHz**

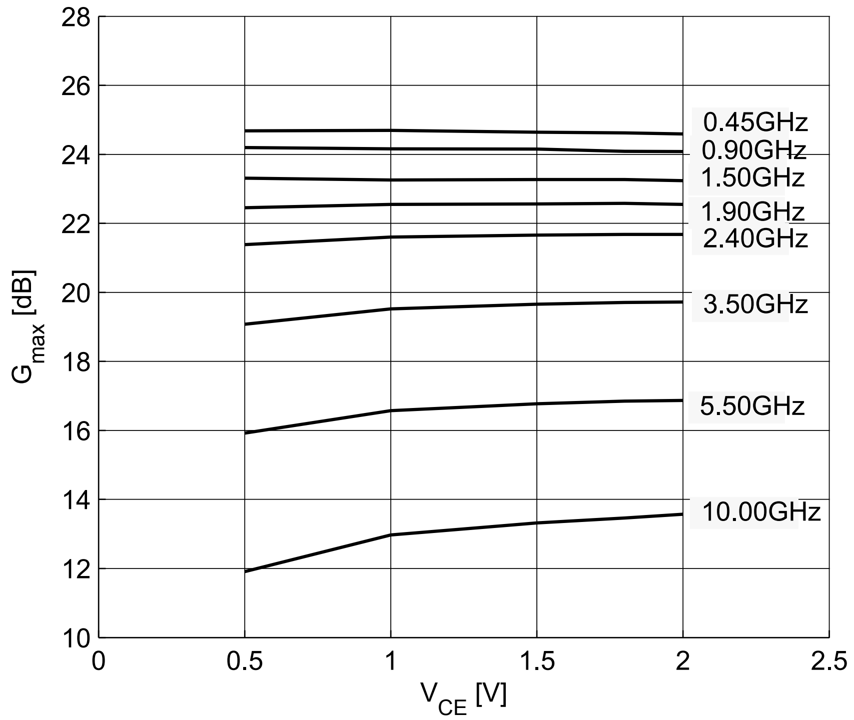

Figure 13 **Maximum power gain G_{max} = f(V_{CE}), I_C = 15 mA, f = parameter in GHz**

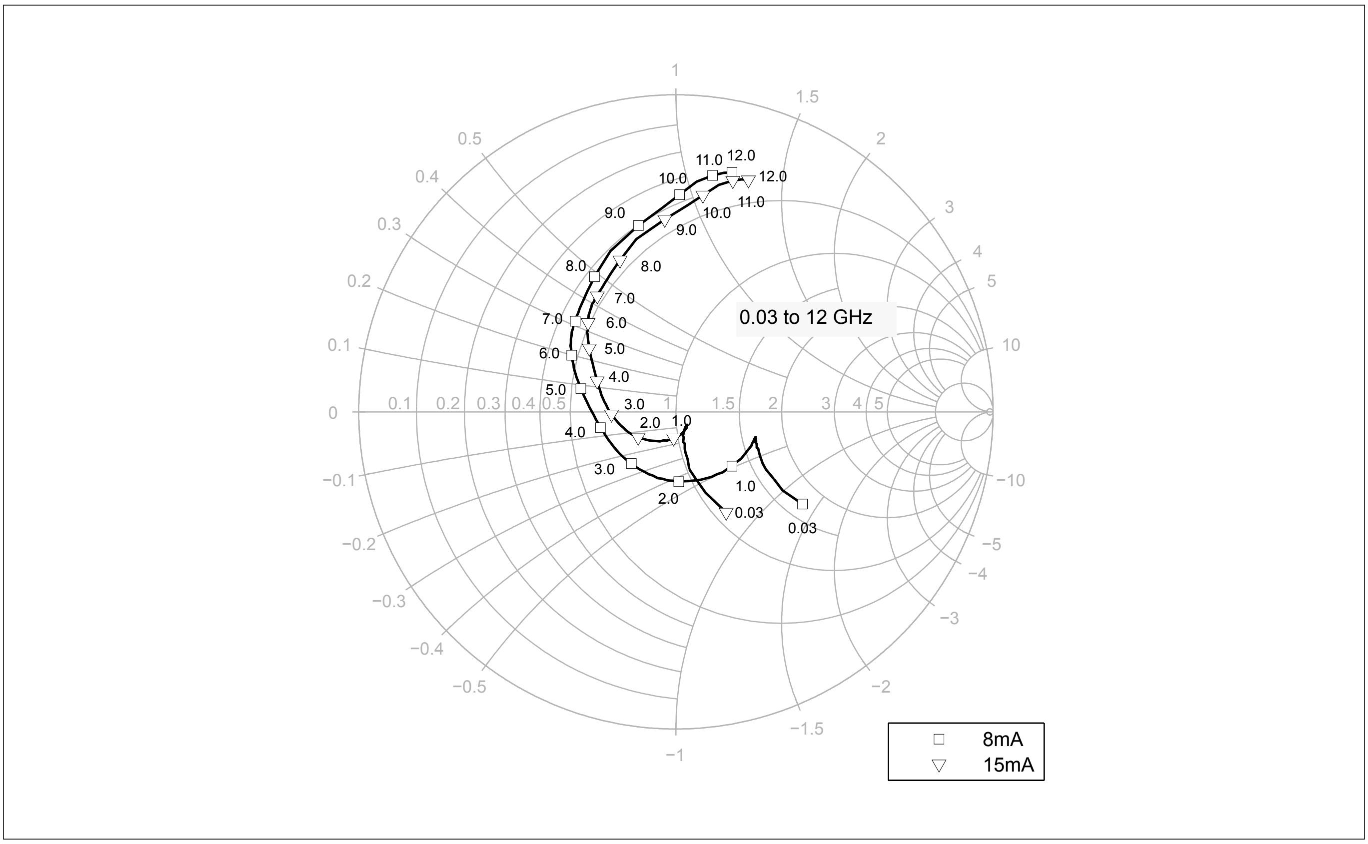

Figure 14 Input reflection coefficient S_{11} = f(f), V_{CE} = 1.8 V, I_C = 8 / 15 mA

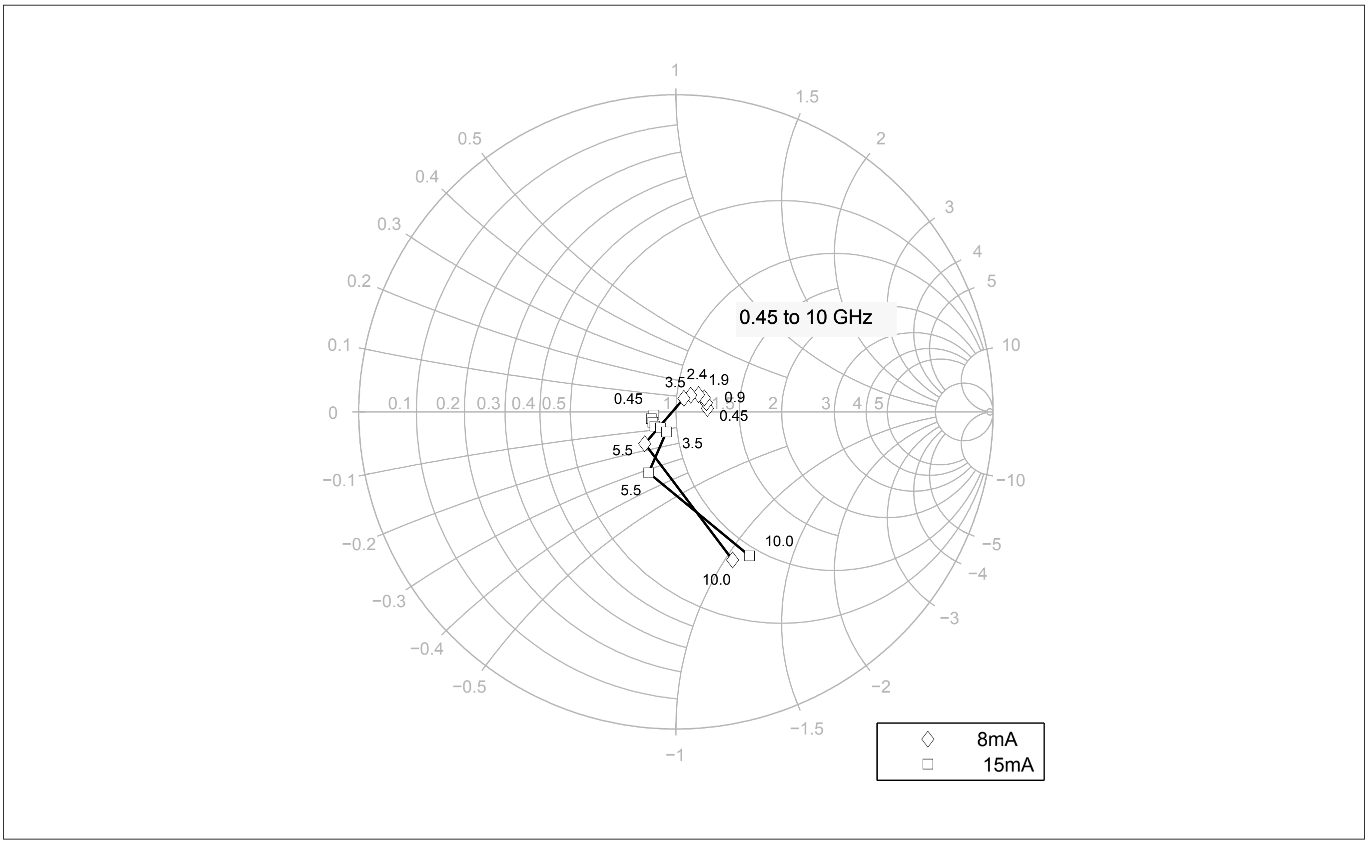

Figure 15 Source impedance for minimum noise figure $Z_{S,opt}$ = f(f), V_{CE} = 1.8 V, I_C = 8 / 15 mA

Electrical characteristics

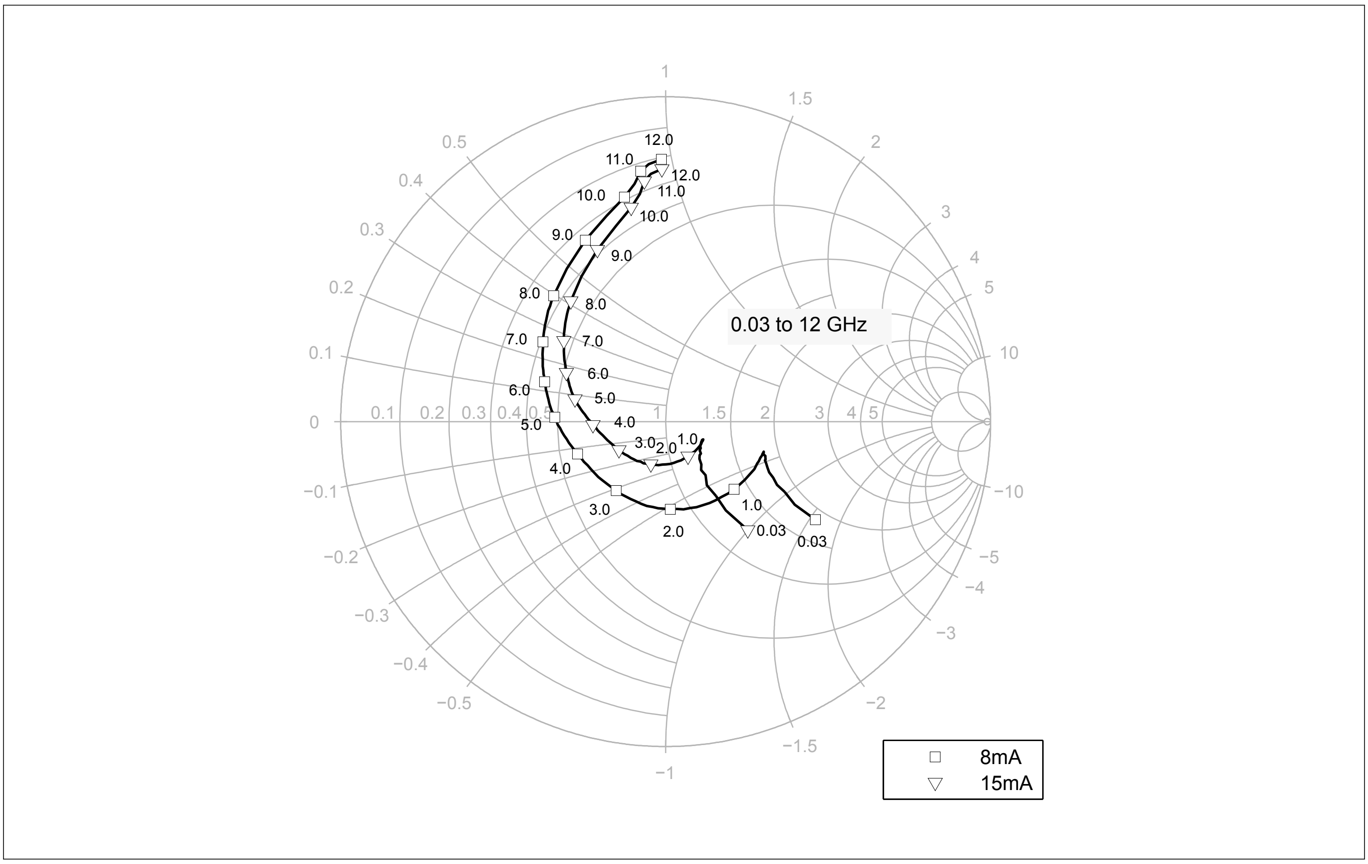

Figure 16 **Output reflection coefficient S_{22} = f(f), V_{CE} = 1.8 V, I_C = 8 / 15 mA**

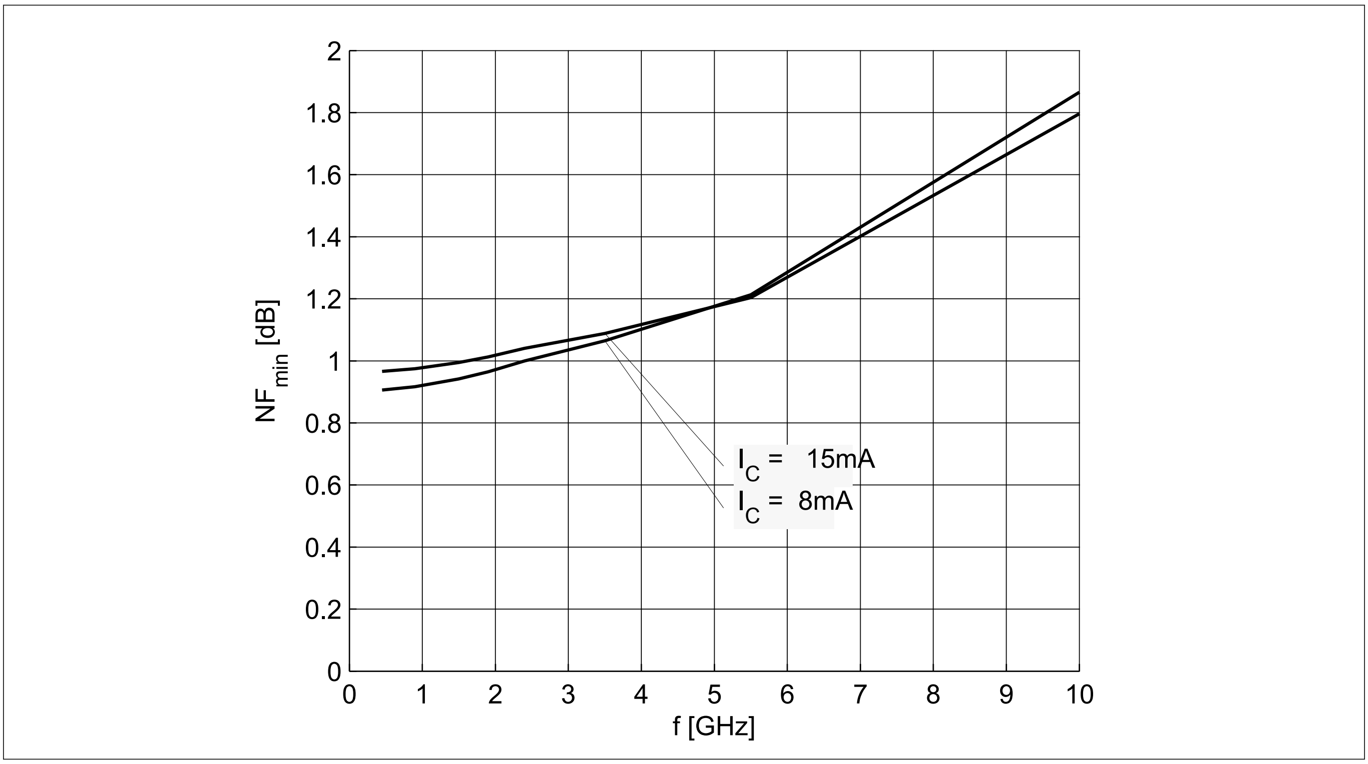

Figure 17 **Noise figure NF_{min} = f(f), V_{CE} = 1.8 V, Z_S = $Z_{S,opt}$, I_C = 8 / 15 mA**

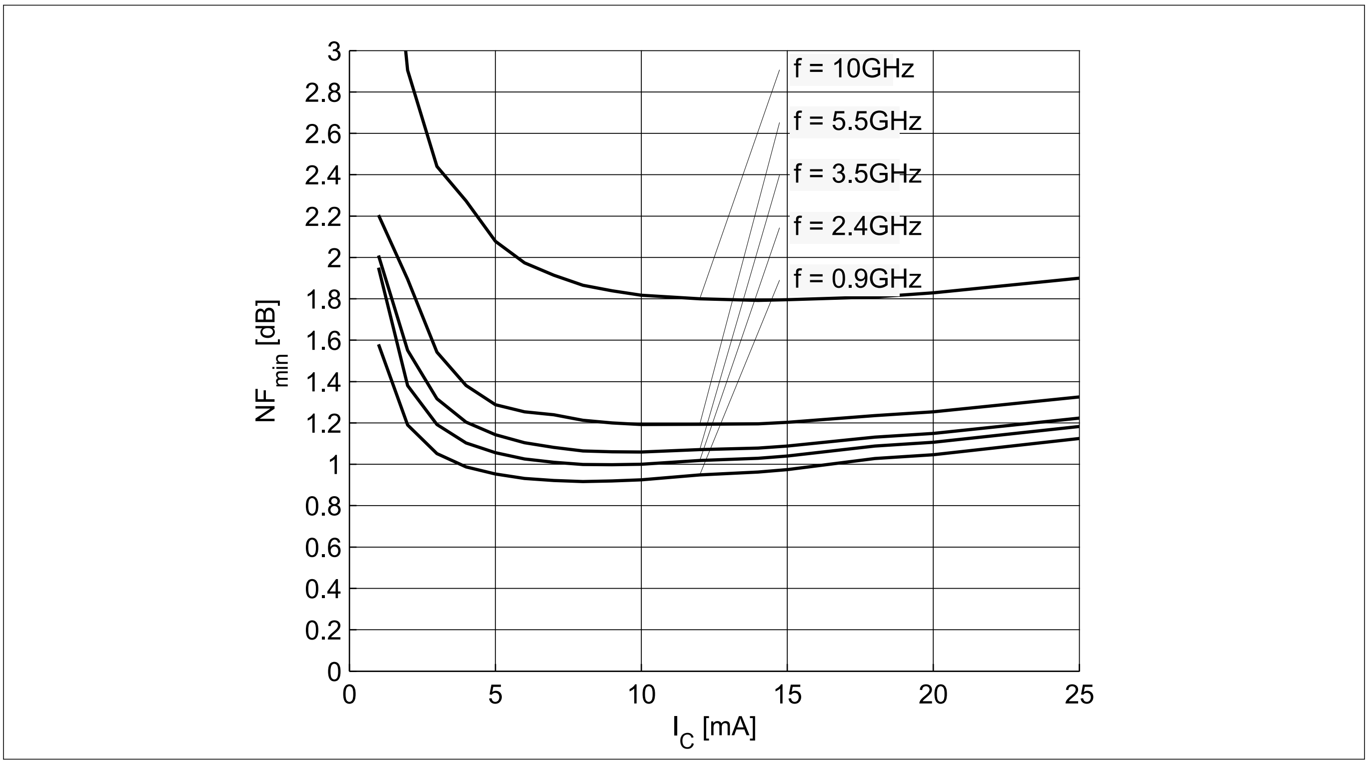

Figure 18 Noise figure NF_{min} = f(I_C), V_{CE} = 1.8 V, Z_S = $Z_{S,opt}$, f = parameter in GHz

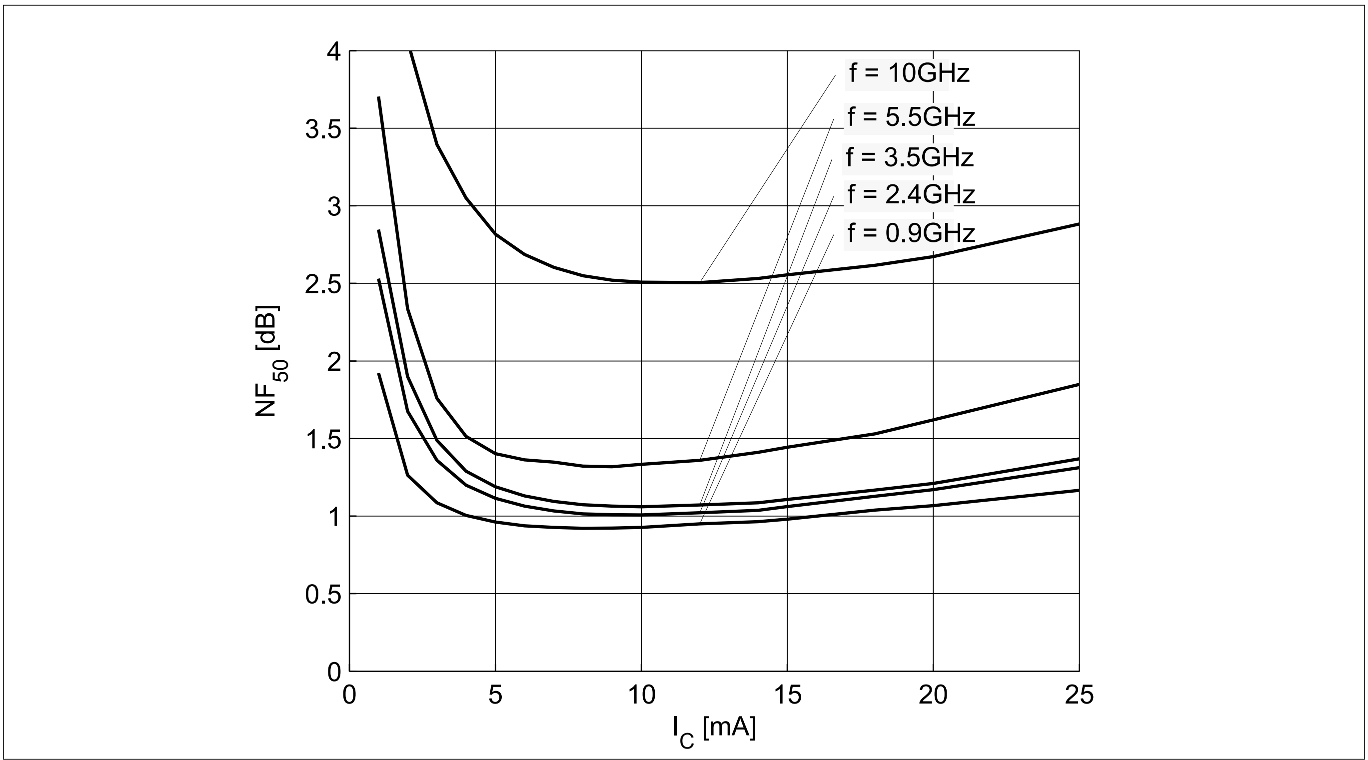

Figure 19 Noise figure NF_{50} = f(I_C), V_{CE} = 1.8 V, Z_S = 50 Ω, f = parameter in GHz

Note: The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves. T_A = *25 °C.*

4 Package information SOT343

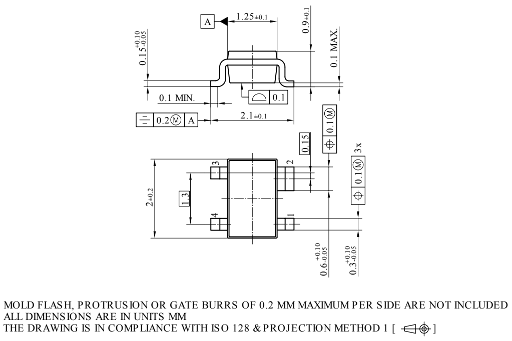

Figure 20 Package outline

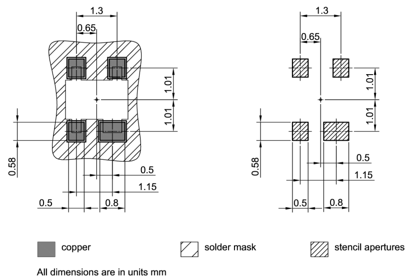

Figure 21 Foot print

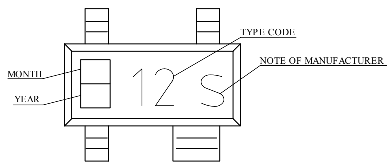

Figure 22 Marking layout example

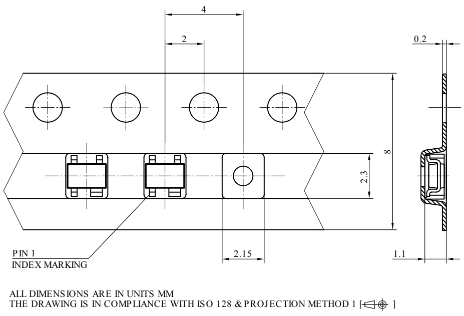

Figure 23 Tape dimensions

Revision history

Document version	Date of release	Description of changes
2.0	2018-26-09	New datasheet layout.

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Edition 2018-09-26

Published by

Infineon Technologies AG

81726 Munich, Germany

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Document reference
IFX-yak1518781510491